

N-channel TrenchMOS standard level FET Rev. 02 — 22 February 2008

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using Nexperia General Purpose Automotive (GPA) TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features

- 175 °C rated
- Q101 compliant

1.3 Applications

- 12 V, 24 V and 42 V loads
- General purpose power switching
- Low on-state resistance
- Standard level compatible
- Automotive systems
- Motors, lamps and solenoids

1.4 Quick reference data

Table 1. **Quick reference**

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	$T_j \geq 25 ~^\circ C; ~T_j \leq 175 ~^\circ C$		-	-	75	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u> and <u>4</u>	<u>[1]</u>	-	-	45	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	158	W
Tj	junction temperature			-55	-	175	°C
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 12}{13} \text{ and } \frac{13}{13}$		-	22	26	mΩ
Avalanche ruggedness							
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$\begin{array}{l} I_{D} = 45 \text{ A}; \ V_{sup} \leq 75 \text{ V}; \\ R_{GS} = 50 \ \Omega; \ V_{GS} = 10 \text{ V}; \\ T_{j(init)} = 25 \ ^{\circ}\text{C}; \ unclamped \\ inductive \ load \end{array}$		-	-	215	mJ

[1] Capped at 45 A due to bondwire.

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2. Pinning information

Table 2.	Pinning				
Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	G	gate	mb	D	
2	D	drain			
3	S	source		G_(IET)	
mb	D	mounting base; connected to drain		mbb076 S	
			SOT428 (DPAK)		

3. Ordering information

Table 3. Ordering information							
Type number	Package	'ackage					
	Name	Description	Version				
BUK7226-75A	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428				

4. Limiting values

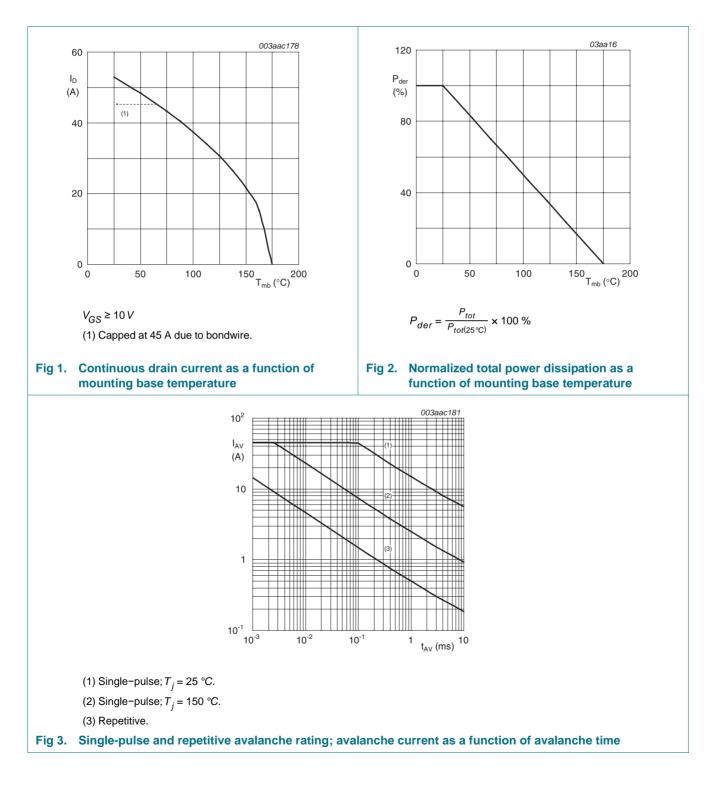
Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

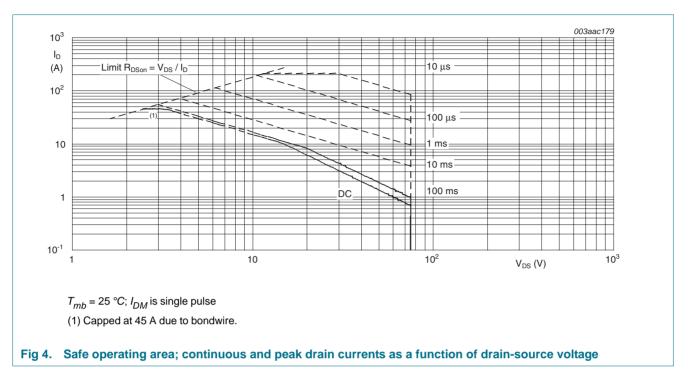
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$	-	75	V
V _{DGR}	drain-gate voltage	R _{GS} = 20 kΩ	-	75	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u> and <u>4</u>	<u>[1]</u> _	45	А
		T_{mb} = 100 °C; V_{GS} = 10 V; see <u>Figure 1</u>	-	38	А
I _{DM}	peak drain current	T_{mb} = 25 °C; $t_p \leq$ 10 $\mu s;$ pulsed; see Figure 4	-	215	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	158	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Avalanc	he ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$\label{eq:ld} \begin{array}{l} I_D = 45 \text{ A}; \ V_{sup} \leq 75 \ V; \ R_{GS} = 50 \ \Omega; \\ V_{GS} = 10 \ V; \ T_{j(init)} = 25 \ ^{\circ}C; \ unclamped \\ inductive \ load \end{array}$	-	215	mJ
E _{DS(AL)R}	repetitive drain-source avalanche energy	see Figure 3	<u>[2][3]</u> _ [4]	-	J
Source-o	drain diode				
l _S	source current	T _{mb} = 25 °C	<u>[1]</u> -	45	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; T_{mb} = 25 °C	-	215	А
		-			

[1] Capped at 45 A due to bondwire.

- [2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.
- [3] Repetitive avalanche rating limited by an average junction temperature of 170 °C.
- [4] Refer to application note AN10273 for further information.



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5. Thermal characteristics

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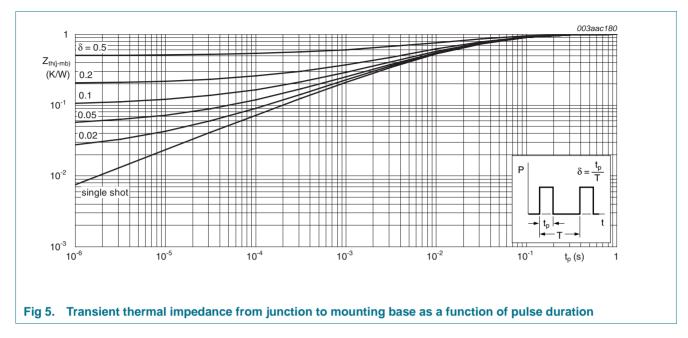
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	minimum footprint; FR4 board	-	70	-	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <u>Figure 5</u>	-	-	1	K/W

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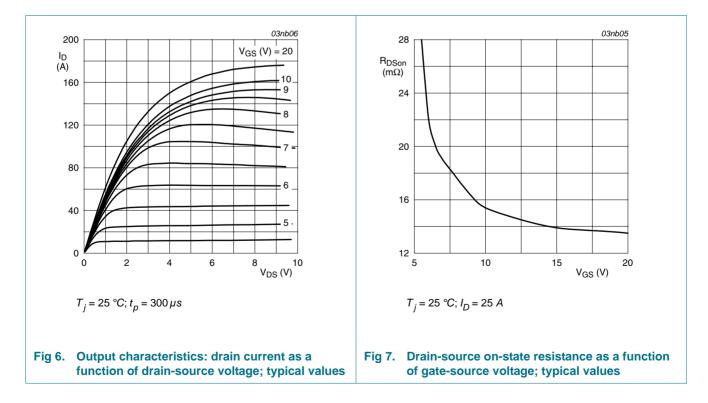


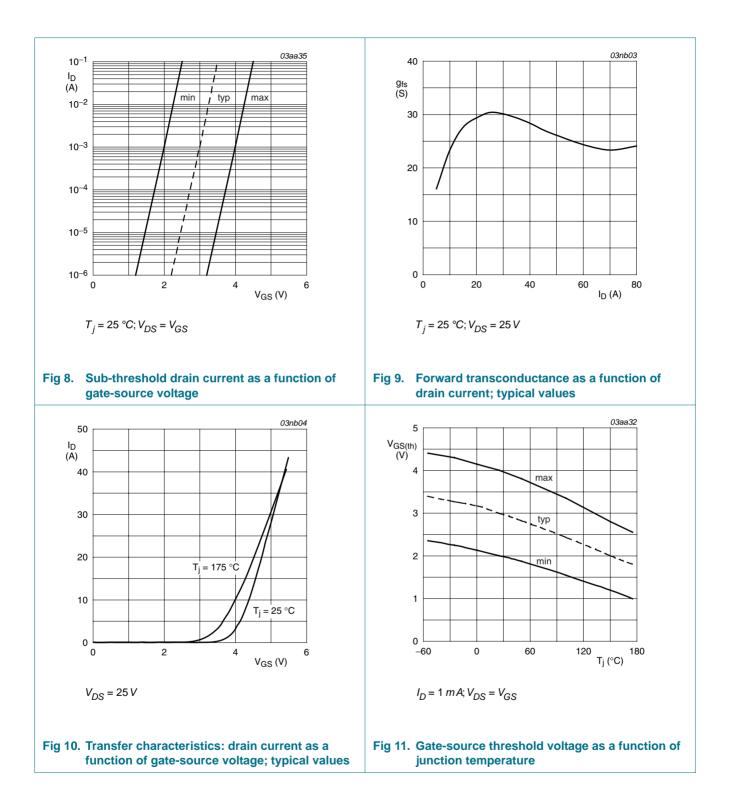
6. Characteristics

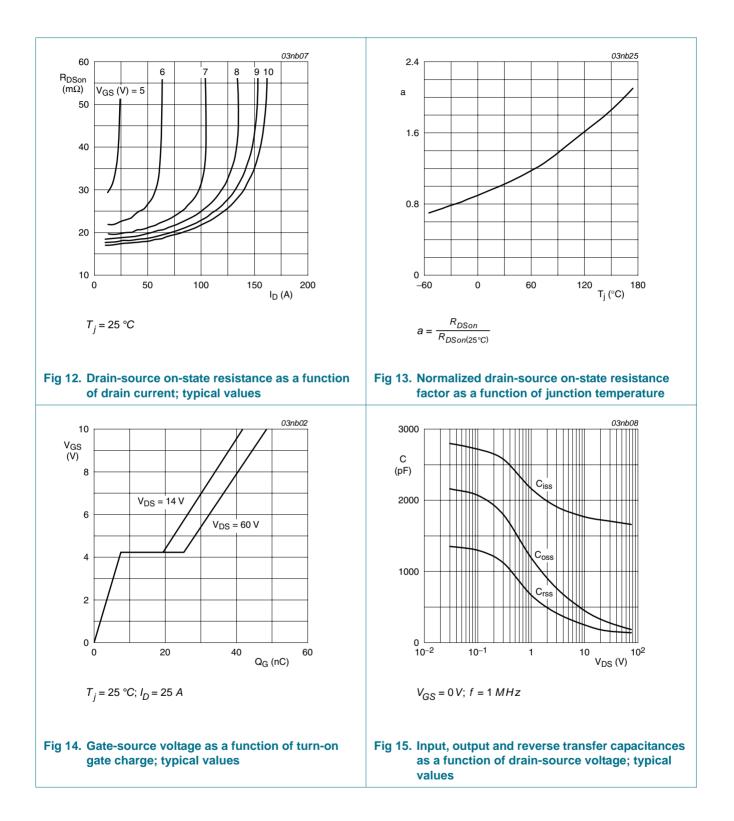
Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I_D = 0.25 mA; V_{GS} = 0 V; T_j = -55 °C	70	-	-	V
		$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V};$ $T_j = 25 \text{ °C}$	75	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 11</u>	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u>	2	3	4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS};$ $T_j = -55 \text{ °C}; \text{ see Figure 11}$	-	-	4.4	V
DSS	drain leakage current	V_{DS} = 75 V; V_{GS} = 0 V; T_j = 25 °C	-	0.05	10	μA
		V _{DS} = 75 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μΑ
I _{GSS}	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 20 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA
		$V_{DS} = 0 \text{ V}; V_{GS} = -20 \text{ V};$ $T_j = 25 \text{ °C}$	-	2	100	nA
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 25 \text{ A};$ T _j = 175 °C; see <u>Figure 12</u> and <u>13</u>	-	-	54	mΩ
		V_{GS} = 10 V; I _D = 25 A; T _j = 25 °C; see <u>Figure 12</u> and <u>13</u>	-	22	26	mΩ
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 16</u>	-	0.85	1.2	V
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{rr}	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s};$	-	53	-	ns
Qr	recovered charge	V_{GS} = -10 V; V_{DS} = 30 V; T _j = 25 °C	-	144	-	nC
Dynamic of	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 60 \text{ V};$	-	48	-	nC
Q _{GS}	gate-source charge	$V_{GS} = 10 V$; see Figure 14	-	7.5	-	nC
Q _{GD}	gate-drain charge		-	17	-	nC
Ciss	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V;$	-	1789	2385	pF
C _{oss}	output capacitance	f = 1 MHz; T _j = 25 °C; - see Figure 15	-	382	458	pF
C _{rss}	reverse transfer capacitance		-	219	300	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \text{ V}; \text{ R}_{L} = 1.2 \Omega;$	-	14	-	ns
t _r	rise time	V _{GS} = 10 V; R _{G(ext)} = 10 Ω; T _i = 25 °C	-	66	-	ns
t _{d(off)}	turn-off delay time	- 1j = 25 C	-	61	-	ns
t _f	fall time		-	41	-	ns
L _D	internal drain inductance	measured from drain lead from package to center of die; $T_j = 25 \ ^{\circ}C$	-	2.5	-	nH
L _S	internal source inductance	measured from source lead from package to source bond pad; $T_i = 25 \ ^{\circ}C$	-	7.5	-	nH

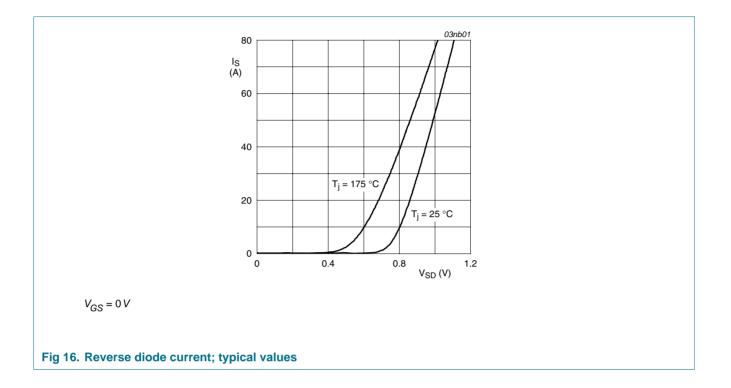






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7. Package outline

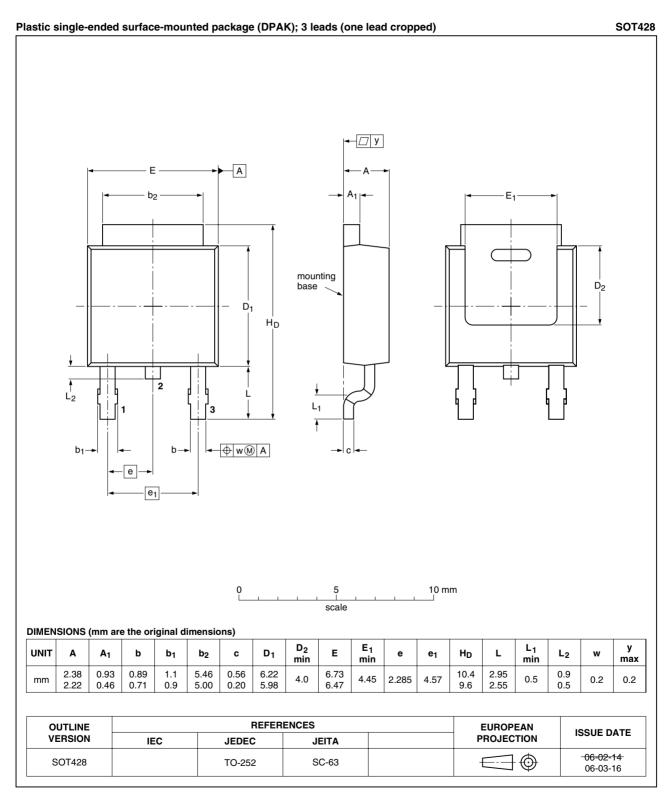


Fig 17. Package outline SOT428 (DPAK)

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8. Revision history

Table 7. Revision h	istory					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BUK7226-75A_2	20080222	Product data sheet	-	BUK7226_75A-01		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
BUK7226_75A-01	20001009	Product specification; in	itial version	-		

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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